International

- Logic-Level Gate Drive
- Advanced Process Technology
- Dynamic dv/dt Rating
- 175°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated
- Lead-Free

Description

Fifth Generation HEXFETs from International Rectifier utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET Power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in a wide variety of applications.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 watts. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.

Parameter Max. Units I_D @ T_C = 25°C Continuous Drain Current, VGS @ 10V 10 $I_{\rm D} @ T_{\rm C} = 100^{\circ}{\rm C}$ Continuous Drain Current, VGS @ 10V 7.1 А Pulsed Drain Current ① 35 I_{DM} $P_D @ T_C = 25^{\circ}C$ Power Dissipation 48 W 0.32 W/°C Linear Derating Factor V_{GS} Gate-to-Source Voltage ± 16 V E_{AS} Single Pulse Avalanche Energy2 85 mJ Avalanche Current① 6.0 А I_{AR} E_{AR} Repetitive Avalanche Energy^① 4.8 mJ dv/dt Peak Diode Recovery dv/dt 3 5.0 V/ns Operating Junction and -55 to + 175 ΤJ Storage Temperature Range T_{STG} °C Soldering Temperature, for 10 seconds 300 (1.6mm from case) Mounting torque, 6-32 or M3 srew 10 lbf•in (1.1N•m)

Absolute Maximum Ratings

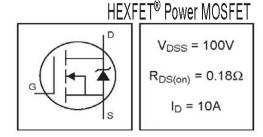
Thermal Resistance

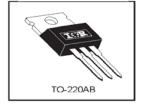
	Parameter	Тур.	Max.	Units
R _{0JC}	Junction-to-Case		3.1	
R _{BCS}	Case-to-Sink, Flat, Greased Surface	0.50		°C/W
R _{0JA}	Junction-to-Ambient		62	

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PD-95668

IRL520NPbF





	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	100			V	$V_{GS} = 0V, I_D = 250 \mu A$
$\Delta V_{(BR)DSS} / \Delta T_{\rm J}$	Breakdown Voltage Temp. Coefficient		0.11		V/°C	Reference to 25°C, I _D = 1mA
				0.18		V_{GS} = 10V, I _D = 6.0A ④
R _{DS(on)}	Static Drain-to-Source On-Resistance			0.22	Ω	V_{GS} = 5.0V, I_{D} = 6.0A ④
				0.26		V_{GS} = 4.0V, I_{D} = 5.0A ④
V _{GS(th)}	Gate Threshold Voltage	1.0		2.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
g fs	Forward Transconductance	3.1			S	V _{DS} = 25V, I _D = 6.0A
1	Drain to Source Looke as Current			25		V _{DS} = 100V, V _{GS} = 0V
DSS	Drain-to-Source Leakage Current			250	μA	$V_{DS} = 80V, V_{GS} = 0V, T_{J} = 150^{\circ}C$
1	Gate-to-Source Forward Leakage			100	nA	V _{GS} = 16V
IGSS	Gate-to-Source Reverse Leakage			-100		V _{GS} = -16V
Qg	Total Gate Charge			20		I _D = 6.0A
Q _{gs}	Gate-to-Source Charge			4.6	nC	V _{DS} = 80V
Q _{gd}	Gate-to-Drain ("Miller") Charge			10		V_{GS} = 5.0V, See Fig. 6 and 13 \circledast
t _{d(on)}	Turn-On Delay Time		4.0			V _{DD} = 50V
t _r	Rise Time		35		ns	I _D = 6.0A
t _{d(off)}	Turn-Off Delay Time		23		115	R_{G} = 11 Ω , V_{GS} = 5.0V
t _f	Fall Time		22			R _D = 8.2Ω, See Fig. 10 ④
L _D	Internal Drain Inductance		4.5		nH	Between lead,
						6mm (0.25in.)
L _S	Internal Source Inductance		7.5	—		from package 🏻 🖓 🏳 🚽
						and center of die contact
Ciss	Input Capacitance		440			V _{GS} = 0V
Coss	Output Capacitance		97		рF	V _{DS} = 25V
Crss	Reverse Transfer Capacitance		50			f = 1.0MHz, See Fig. 5

Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

Source-Drain Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
Is	Continuous Source Current			10		MOSFET symbol
	(Body Diode)		10	A	showing the	
I _{SM}	Pulsed Source Current			—– 35		integral reverse 🛛 🖓
	(Body Diode) ①⑥					p-n junction diode.
V _{SD}	Diode Forward Voltage			1.3	V	$T_{ m J}$ = 25°C, $I_{ m S}$ = 6.0A, $V_{ m GS}$ = 0V ④
trr	Reverse Recovery Time		110	160	ns	T _J = 25°C, I _F =6.0A
Qrr	Reverse RecoveryCharge		410	620	nC	di/dt = 100A/µs
t _{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (tum-on is dominated by L_S+L_D)				

Notes:

① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11)

 3 I_{SD} \leq 6.0A, di/dt \leq 340A/µs, V_{DD} \leq V_{(BR)DSS}, T_{\rm J} \leq 175°C

Pulse width \leq 300 $\mu s;$ duty cycle \leq 2%.

International **IGR** Rectifier

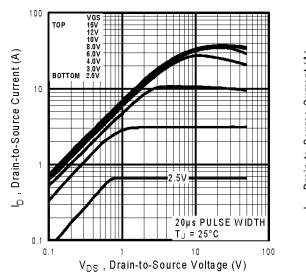


Fig 1. Typical Output Characteristics

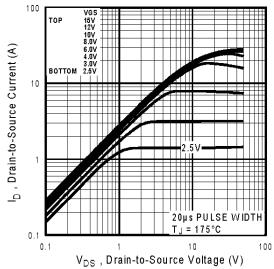


Fig 2. Typical Output Characteristics

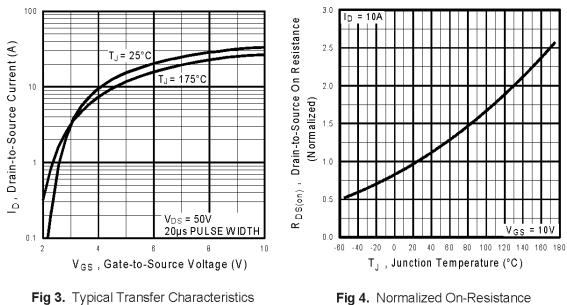


Fig 4. Normalized On-Resistance Vs. Temperature

International **IGR** Rectifier

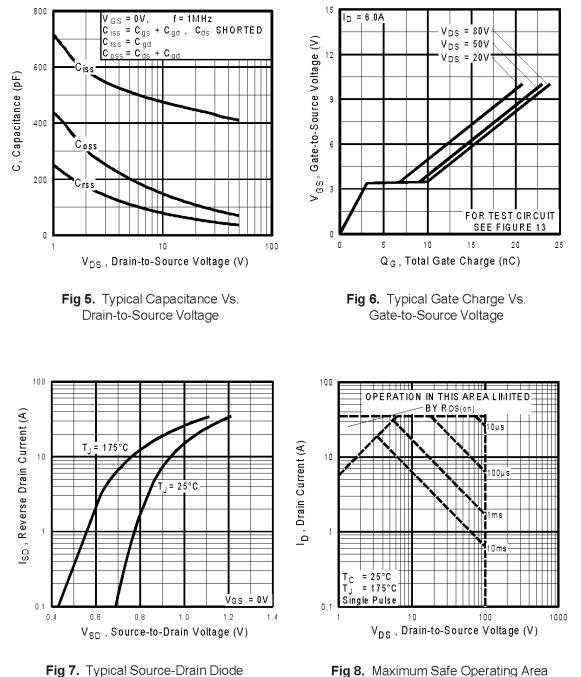
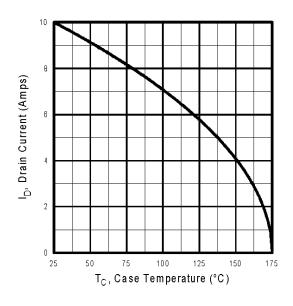


Fig 8. Maximum Safe Operating Area

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Forward Voltage

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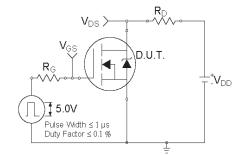


Fig 10a. Switching Time Test Circuit

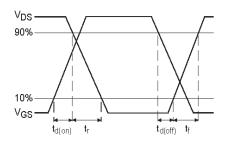
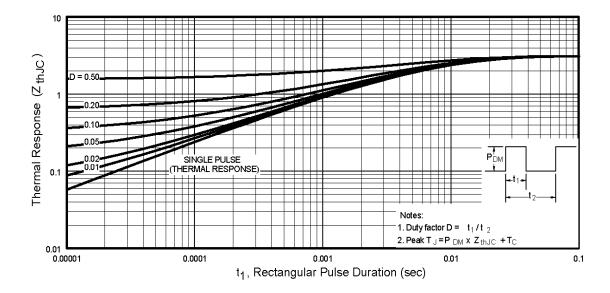


Fig 10b. Switching Time Waveforms



rig II. waximum Enective transient mennarimpedance, Junction-Case

International

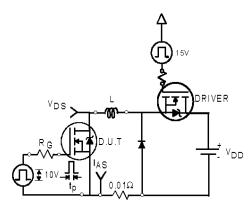


Fig 12a. Unclamped Inductive Test Circuit

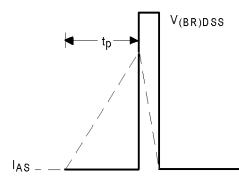


Fig 12b. Unclamped Inductive Waveforms

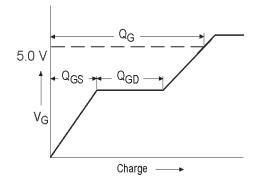


Fig 13a. Basic Gate Charge Waveform

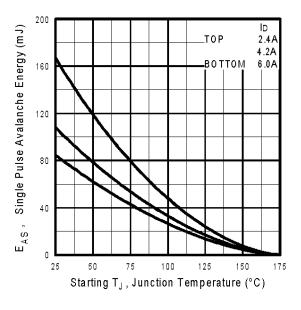


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

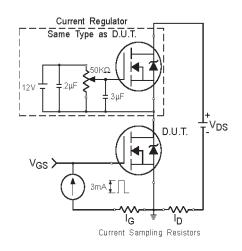
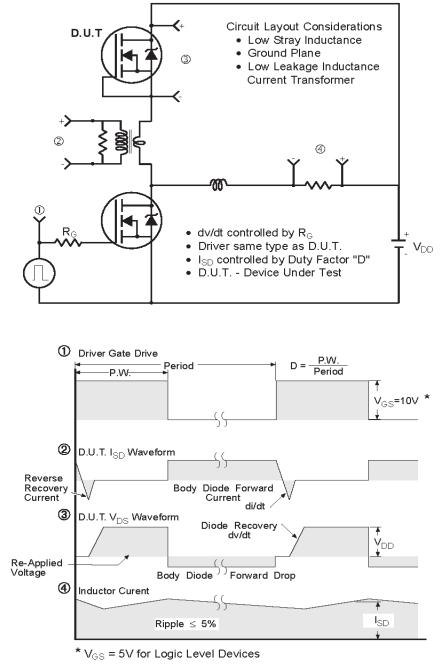


Fig 13b. Gate Charge Test Circuit www.irf.com

International **TOR** Rectifier

IRL520NPbF

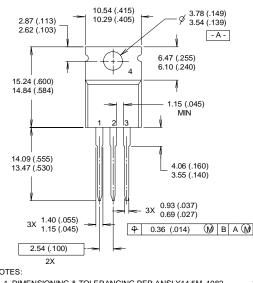
Peak Diode Recovery dv/dt Test Circuit

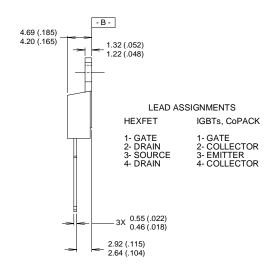




TO-220AB Package Outline

Dimensions are shown in millimeters (inches)





International

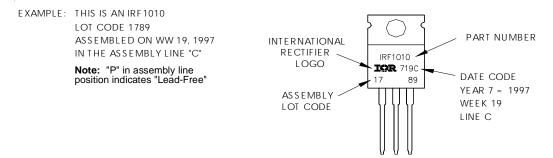
TOR Rectifier

NOTES

1 DIMENSIONING & TOLERANCING PER ANSI Y14.5M, 1982. 2 CONTROLLING DIMENSION : INCH

3 OUTLINE CONFORMS TO JEDEC OUTLINE TO-220AB. 4 HEATSINK & LEAD MEASUREMENTS DO NOT INCLUDE BURRS.

TO-220AB Part Marking Information



Data and specifications subject to change without notice.

International **ICR** Rectifier

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